

An Optimized Measurement Algorithm for Gas Sensors Based on Carbon Nanotubes: Optimizing Sensor Performance and Hardware Resources

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Abstract—This paper presents a novel algorithm for the measurement of resistive-type gas sensors with carbon nanotubes (CNTs) as sensitive layer. Contrary to conventional strategies, which extract the sensor information from the normalized resistance, the proposed algorithm is based on the variation in resistance over time. The results have demonstrated that the time necessary to get the maximum performance of these sensors is reduced around a 25% when compared with the conventional approach for any of the recovery strategies analyzed (passive desorption, external heating, or dc voltage). The hardware implementation of the proposed algorithm in a field-programmable gate array (FPGA) has also demonstrated that, in addition to optimizing the sensor performance in terms of time response and sensitivity, this measurement algorithm yields a significant minimization of the sensor readout circuit resources at both software and hardware levels paving the way for future development of smart sensors for the Internet of Things (IoT) applications.

Index Terms—Carbon nanotube (CNT), field-programmable gate array (FPGA), inkjet printing, NH₃, recovery, single-walled, spray deposition.

I. INTRODUCTION

RECENTLY, gas leakage detection is a topic of high interest in diverse fields from personal to industrial applications. In this context, thanks to the rapid advances in the development of wireless sensors devices into the Internet of Things (IoT) paradigm, there is a current trend toward the ubiquitous sensing. However, significant challenges remain concerning the widespread availability of this kind of devices for end-user applications. On the one hand, sensors need to be lightweight, low-power, robust, and small in size and, on the other hand, the algorithms implemented in the IoT devices must be optimized to minimize both computing resources and time, and consequently, the power consumption.

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Therefore, it is clear that the convergence between nanotechnology (new materials and detection methods, manufacturing processes, device integration, etc.) and both measuring and processing algorithms is mandatory to move forward in this effort [1].

Regarding gas sensors, resistive ones are very popular because of their reasonable price and good durability [2]. However, they are commonly limited in their selectivity and sensitivity, boosting research to develop new materials and detection methods for a better gas discrimination [3]. In this direction, functional materials have received a lot of attention. A large variety of electrical sensor materials have been investigated, including semiconducting metal oxides, silicon devices, organic materials, carbon nanotubes (CNTs) and carbon black-polymer composites [4]. These new materials are normally tuned by functionalizing them with metal and polymers to achieve selectivity toward certain gas species [5]; however, the vast majority of the solutions are time and power demanding. Therefore, several approaches have been developed toward facing these issues, for instance, higher-order sensing systems which consist of sensor arrays covered with different sensitive layers [6], using pattern recognition algorithms [7], or multifunctional sensors which measure different properties of a sensitive layer [8]. Furthermore, it is desirable to recover the sensor response over time, that is to say, to desorb the trapped molecules in the sensing element after being exposed to the gas. A common strategy to recover the sensing layer is to externally heat the sensor to increase the desorption rate of the trapped molecules [9]–[11]. This approach normally requires the integration of more circuitry and higher power consumption. Recently, we have reported the capability of CNTs gas sensors to self-recover by applying a higher than probing dc voltage between its terminals, reducing the power demand of the system as well as not requiring more circuit elements for the recovery stage [12]. A lot of effort has been put in developing this kind of gas sensor because they present high sensitivity toward a variety of gas species [5], [13], [14], can be manufactured with cost-effective techniques [15], [16] and can be deposited on flexible substrates [17], [18], providing a promising starting point for the industrial use of this technology. However, very limited attention has been paid to their transduction mechanisms in terms of the requirements to be integrated at system level.

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Conventionally, the information of resistive sensors is extracted from their normalized resistance (NR). In other words, it is measured the relative change in resistance when the sensor is exposed to the parameter of interest with respect to its value under base level conditions [10], [19], [20]. One essential part of any sensory system, mostly neglected by basic research, is the integration of the sensing element in a complete electronic system. This requires the design of circuits to adapt the sensor signal and efficiently and accurately extract the sensor information [21].

In this paper, we propose a new algorithm to analyze the response of a CNT gas sensor based on its relative change of resistance over time and we demonstrate its superiority over the NR, the conventional approach, at the sensor performance and at the employed hardware resources for extracting information. We investigate this novel approach in terms of time response, sensitivity, and level of integration in final systems. One of the most desirable aspects in the field of instrumentation is to bring the intelligence to the sensor elements through the applications of low computational cost, small size, and low consumption. Thus, the measurement algorithm proposed in this paper allows optimizing the resources of implementation and computation, making feasible the future development of a smart sensor, crucial for the truly development of the paradigm of the IoT.

This paper is organized as follows. In Section II, the design and fabrication of the sensor is described together with its characterization procedure. Section III describes the proposed algorithm and presents its empirical results in comparison with the conventional method. At the end of this section, it is analyzed the system requirements of each approach and their feasibility of circuitry integration. Finally, the main conclusions are drawn in Section IV.

II. MATERIALS AND METHODS

A. Fabrication Process

Initially, we sprayed the CNT solution on the polyimide substrate (Kapton HN) of $125\ \mu\text{m}$ -thickness. The CNTs were dispersed in an aqueous solution based on 1 wt.% sodium dodecyl sulfate (SDS). After stirring the solution for 1 h, 0.03 wt.% CNTs were added to the dissolved dispersion agent. The obtained solution was sonicated for 30 min using horn sonicator at 50% of its maximum power ($\sim 48\ \text{W}$). After 1.5 h of centrifugation at 15 000 rpm, the top part of the solutions was removed from the vials to be used for the deposition, while the bottom 20% was disposed. By mounting an air atomizing spray valve (Nordson EFD, USA), to a motorized X-Y platform (Precision Valve & Automation, USA), it was possible to obtain a repeatable spray process, using an approach similar to what previously reported [17], [18]. After deposition, the samples were immersed in deionized water for 15 min at room temperature to remove the dispersant, and subsequently dried. Then, on top of the CNT film, we defined the electrodes, using a DMP-2831 Dimatix printer (Fujifilm Dimatix, Inc., Santa Clara, CA, USA) fixing the plate temperature during the printing at $60\ ^\circ\text{C}$. The electrodes were made of one layer of silver nanoparticles (DGP 40LT-15C from ANP Company, USA),

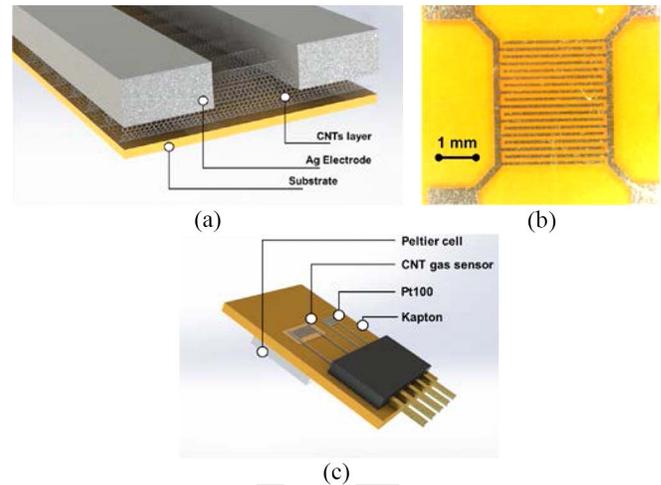


Fig. 1. (a) Schematics of the fabricated sensors. (b) Real picture of the sensor. (c) Schematic of sensor module.

defining the drop space to $50\ \mu\text{m}$. The finger width and the space between fingers are $100\ \mu\text{m}$ and the finger length $3\ \text{mm}$. After printing and drying of the electrodes, they were photonic sintered (Sinteron 2010 from Xenon, USA) with five pulses of $2.5\ \text{kV}$ energy and $500\ \mu\text{s}$ width. Fig. 1(a) illustrates the layers of the manufactured device and Fig. 1(b) presents a real picture of the developed sensor.

The complete sensor module includes the resistive sensor, mounted on a carrier glass together with a Peltier heating element for temperature control and a temperature sensor (Pt100) for *in-situ* monitoring [Fig. 1(c)].

B. Characterization Process

Sensors were measured by monitoring the variation in resistance with respect to the test gas concentration. Before the sensor response toward test gas was analyzed, the initial resistance of the sensor was monitored over time to determine its baseline. After reaching a stable initial value, the sensor module was introduced inside a gas chamber and its response was evaluated by exposing it to different concentrations of test gas. Fig. 2 illustrates a measurement cycle, which is composed of an exposure interval followed by a recovery interval and then an interval at normal conditions. The room temperature was set to *circa* 22° , and in each stage, nitrogen was employed as carrier gas to be certain that the measurement result would only be influenced by the target gas. In “normal conditions” phases, the carrier gas flow was set to $200\ \text{ml/min}$. During exposure phases, the overall mixture flux was set to a constant $200\ \text{ml/min}$ for a given time at ambient temperature [stage (c) in Fig. 2].

Recovery was then introduced, following three different strategies [stage (b) in Fig. 2]: 1) externally heating the sensor, with a Peltier cell, to $80\ ^\circ\text{C}$; 2) applying $10\ \text{V}$ among the sensor terminals to establish a self-heating condition; and 3) passive recovery (leaving the sensor under ambient conditions). For ease of comparison, every recovery strategy was tested with the same conditions (unchanged room temperature, $200\ \text{ml/min}$ flux of carrier gas). After these recovery

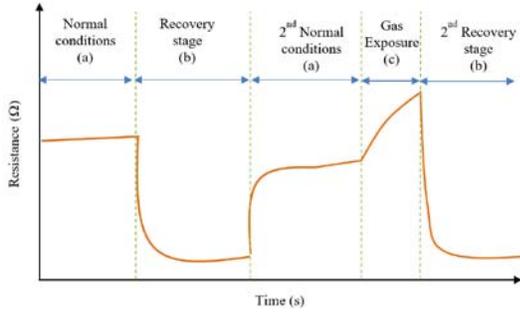


Fig. 2. Schematic of the measurement flow, pointing out the different stages. (a) Operation at normal conditions. (b) Recovery step. (c) Exposure to gas.

171 phases, the high flux was kept once more at ambient condi-
 172 tions [stage (a) in Fig. 2] to facilitate the recuperation of the
 173 device and purge any residual test gas molecules out of the gas
 174 chamber. Recovery stage ended by a final step under sensing
 175 conditions (200 ml/min of carrier gas at ambient conditions)
 176 to help restore the initial resistance before the next expo-
 177 sure cycle. We performed two different measurement tests,
 178 a longer one where all the steps in the cycle had a duration
 179 of 300 s and a shorter one with the duration of the steps
 180 fixed at 150 s.

181 The measurements were automated with LabVIEW
 182 2016 software, which controlled an impedance analyzer
 183 (Keysight E4990A) with an impedance probe kit (4294A1) for
 184 the sensor readout (impedance). The excitation voltage applied
 185 in all measurements was $V_{dc} = 0$ and $V_{ac} = 500$ mV and
 186 the frequency swept ranged from 20 to 100 Hz. The dc volt-
 187 age to perform the recovery stage was directly applied by the
 188 impedance analyzer. The phase in all frequencies was below
 189 10^{-30} , proving the virtually pure resistive behavior of the
 190 device under test. In particular, the NH_3 concentrations tested
 191 covered a range between 10 and 80 ppm, achieved by diluting
 192 the test gas with nitrogen as carrier gas.

193 III. RESULTS AND DISCUSSION

194 In this section, we will first show the analysis of the
 195 described sensor using the proposed measurement methods
 196 and comparing its performance with the conventional proce-
 197 dure. After that, we will show the influence of the recovery
 198 strategy in this new measurement protocol, followed by the
 199 use of this protocol to the response of the sensor toward
 200 other gases. Finally, we will show a study of the efficiency
 201 of the described measurement protocol in comparison with
 202 the conventional one in hardware and software final solutions.

203 In the following sections, we present the mean values of
 204 three complete measurements cycles. The errors are lower than
 205 2% in all cases.

206 A. Response to Ammonia

207 In order to evaluate the sensor performance, the conven-
 208 tional measurement protocol is based on the NR presented in
 209 (1): the difference in resistance before and after the exposure
 210 divided by this initial resistance. What we propose is to fix the
 211 measurement time and only measure the variation in resistance

in the chosen time slot, see (2)

$$\text{Normalized Resistance}(\%) = \frac{R_f - R_i}{R_i} \quad (1) \quad 212$$

$$\text{Temporal Resistance Variation} \left(\frac{\Omega}{s} \right) = \frac{R_f - R_i}{T} \quad (2) \quad 213$$

215 where R_i and R_f are the initial and final resistance values of
 216 an exposure cycle, respectively, and T is the reference time
 217 interval. Notice that once that after the calibration, an optimal
 218 value of T will be found, it shall be considered as constant.
 219 On the contrary, looking to (1), the initial resistance of the
 220 CNT film cannot be considered as constant, since the baseline
 221 value is not necessarily recovered after exposure.

222 The time response of such gas sensing systems is tradition-
 223 ally modeled as a “charging” circuit, with a classic growing
 224 negative exponential response [22]

$$R(t) = R_i + \Delta R(C) \left(1 - e^{-\frac{t}{\tau}} \right) \quad (3) \quad 225$$

$$R'(t) = \frac{\Delta R(C)}{\tau} e^{-\frac{t}{\tau}} \quad (4) \quad 226$$

$$NR' = \frac{\Delta R(C)}{R_i \tau} e^{-\frac{t}{\tau}}. \quad (5) \quad 227$$

228 The derivative of the time evolution of resistance—and,
 229 hence, the NR—after exposure is always strictly positive, as
 230 presented in (4) and (6), respectively. This implies that the
 231 NR will have an increasing value until the slope will be
 232 only marginally increased, and saturation can be considered
 233 reached. The saturation point, however, could be substantially
 234 different, depending on the network properties. The proposed
 235 characterization feature, on the other hand, focuses on the tem-
 236 poral resistance variation (TRV), introduced in the previous
 237 section. The TRV will quickly reach its maximum and then
 238 decrease over time, toward a more stable value. Proceeding
 239 similar to what we did for the NR, it is possible to write TRV
 240 and its derivative as

$$\text{TRV}(t) = \frac{\Delta R(C)}{t} \left(1 - e^{-\frac{t}{\tau}} \right) \quad (6) \quad 241$$

$$\text{TRV}'(t) = -\frac{\Delta R(C)}{t^2} \left(1 - e^{-\frac{t}{\tau}} \right) + \frac{\Delta R(C)}{t\tau} e^{-\frac{t}{\tau}}. \quad (7) \quad 242$$

243 Thus, the derivative with respect to time of TRV is strictly
 244 negative and quickly approaching zero. The maximum of the
 245 TRV response will be observed immediately after exposure.

246 Fig. 3(a) and (b) shows the NR while the sensor is exposed
 247 to the test gas, whereas Fig. 3(c) and (d) presents the TRV
 248 during the test gas exposure. In particular, Fig. 3(a) and (c)
 249 corresponds to 150 s exposure while Fig. 3(b) and (d) to 300 s.
 250 It can be observed how the shapes of the curves are independ-
 251 ent on the exposure time. In the case of the NR, the sensor
 252 has not achieved the saturation point. If the exposure takes
 253 longer, it is expected to have an increase in the NR and, there-
 254 fore, the response of the sensor would be higher, the longer
 255 the exposure is. Contrary to this behavior, the TRV depicts
 256 a faster increase in its response around the first 50 s exposure
 257 and it tends to a constant value above 120 s. This response
 258 provides us a new resource to characterize this sensor, ensur-
 259 ing a stable value and, especially, facilitating its integration in
 260 final systems.

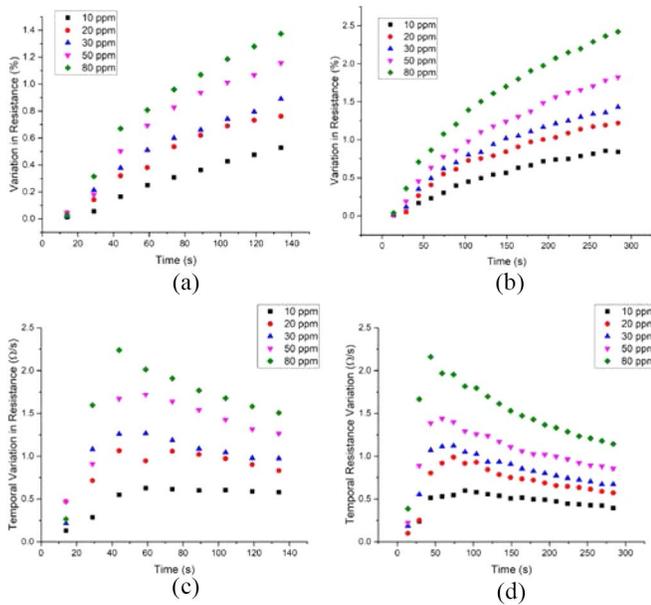


Fig. 3. NR over time for different NH_3 concentrations with an exposure time of (a) 150 s and (b) 300 s. TRV over time at the same NH_3 concentrations with an exposure time of (c) 150 s and (d) 300 s.

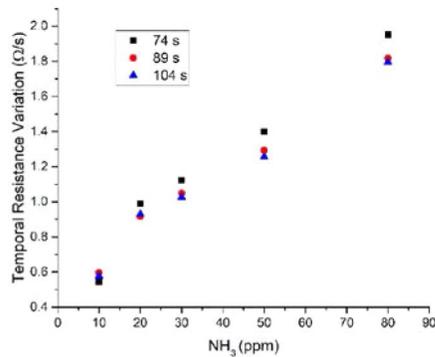


Fig. 4. Temporal resistance variation versus ammonia concentration at different exposure times.

The calibration curve of the sensor considering the TRV over NH_3 concentration is illustrated in Fig. 4, selecting three different point of time. At 74 s, the response is slightly higher than at longer time exposure. Contrary to the traditional measurement (NR), longer exposure time does not ensure a better response of the sensor.

Basically, when using NR, the response achieves its maximum at saturation and to reach this point we have to wait until the resistance stabilizes (meaning in this case, a time longer than 300 s). Opposite to this approach, when applying TRV, how fast the resistance changes with the concentration exhibits an increase at the beginning until reach a maximum (in this case, about 75 s) and then stabilized.

The linear regression curves extracted from data in Fig. 4 are presented in (8)–(10) for 74, 89, and 104 s, respectively

$$\text{TVR}(\Omega/s) = 0.01844 \cdot [\text{NH}_3] + 0.50105, R^2 = 0.95138 \quad (8)$$

$$\text{TVR}(\Omega/s) = 0.01631 \cdot [\text{NH}_3] + 0.51455, R^2 = 0.97501 \quad (9)$$

$$\text{TVR}(\Omega/s) = 0.01603 \cdot [\text{NH}_3] + 0.50833, R^2 = 0.96319. \quad (10)$$

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Notice an important improvement that TRV achieves compared to the NR for the integration of the sensing element in a complete electronic system. For the computation of the NR it can be observed that (1) includes a division to an arbitrary real number (the measured initial resistance value). This arithmetic operation, albeit important, is far more complex than addition and multiplication, and requires significant amount of resources for a complete hardware implementation [23], [24]. Thus, a challenge, sometimes difficult to achieve, is to be able to manipulate the algebraic expression in order to convert it into another one that only includes multiplications and/or additions. Achieving the above would make it possible to get an area reduction and performance improvement of the hardware implementation, a very important aspect to be able to provide a competitive portable design. In this sense, for the computation of the TRV, (2) matches the requirements of the previous challenge, since the term T is a constant value, statically chosen in design phase, and the division by this constant can be easily converted into a multiplication [25]. Thus, in addition to the advantage related to the faster increase in its response, the TRV facilitates the integration in final systems.

Similar results have been found for ethanol (see Fig. S1), demonstrating the wider use of the proposed algorithm.

Muezzinoglu [26] also proposed an analysis of the transient response of chemo-resistive sensors providing a faster response without waiting until the sensor achieve the equilibrium point. However, in their approach, it is needed to employ various multiplications; while, in our algorithm, only one simple multiplication is needed. Moreover, contrary to them, we demonstrate that no data transformation is needed to extract the sensor information.

B. Response Using Different Recovery Strategies

The recovery of the sensor to its baseline after finishing the exposure to the gas is an important feature of any gas sensor, although the vast majority does not completely recover to their baseline but they show substantial drifts after different exposure cycles [27], [28]. SWNT gas sensors are one of those devices that do not recuperate the baseline at ambient conditions after exposure to a test gas [29]. In order to force the sensor to recover its initial characteristics, it is necessary to provide extra energy in the form of heat or gate biasing or UV light [29]–[32]. The data presented in Figs. 3 and 4 corresponds to a recovery strategy based on external heating (in this case, at 80 °C), as this is the most established approach. Nevertheless, recently it has been proved that a similar effect can be achieved by applying a dc voltage [12]. Even in this case, however, the power demand of the sensing system is significantly higher than what a simple resistance measurement would require. Resultantly, an even more remarkable finding would be to avoid the recovery to the baseline, leaving the sensor to passively get rid of the trapped molecules (passive recovery), and still be able to guarantee high and repeatable response.

Fig. 5 shows the analysis presented in the previous section for dc voltage recovery [Fig. 5(a) and (b)] and for passive recovery [Fig. 5(c) and (d)]. The shapes obtained are similar

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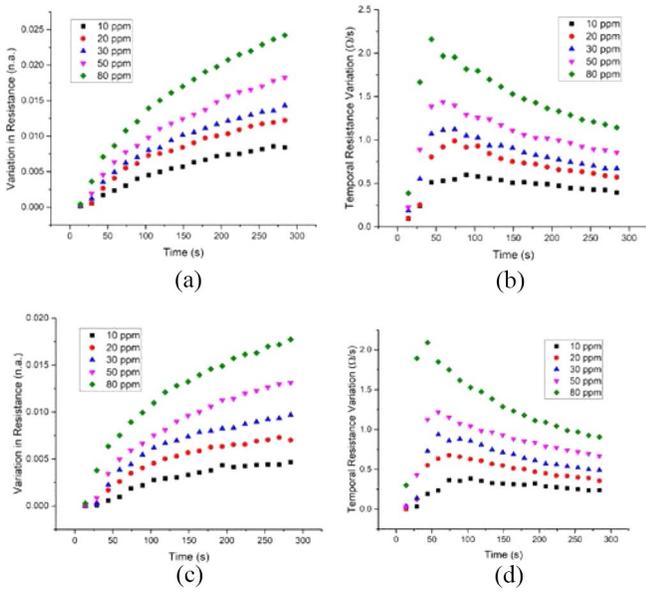


Fig. 5. (a) NR over time for different NH₃ concentrations with an exposure time of 300 s and recovery at 10 V. (b) TRV over time at the same NH₃ concentrations with an exposure time of 300 s and recovery at 10 V. (c) NR over time for different NH₃ concentrations with an exposure time of 300 s and passive recovery. (d) TRV over time at the same NH₃ concentrations with an exposure time of 300 s and passive recovery.

336 to the external heating recovery for both NR and TRV. When
 337 we look at the NR, the active recovery strategies (heating at
 338 80 °C and applying 10 V) achieve around 2.5% at 80 ppm
 339 NH₃ after 300 s, while the response is below 2% for passive
 340 recovery at the same concentration and point of time. But when
 341 we look at the TRV, this difference is reduced. For example,
 342 we measured 1.9 Ω/s at 80 ppm NH₃ and 74 s for heating
 343 recovery, 2.0 Ω/s for dc voltage recovery, and 1.8 Ω/s for
 344 passive recovery. Hence, the response loss with respect to the
 345 active recovery case is 18% and 5% for the NR and TRV
 346 methods, respectively.

347 *C. Performance in Real Measurement Instrument*

348 Hardware implementation in field-programmable gate
 349 array (FPGA) of NR and the new proposal based on
 350 TRV have been evaluated and compared. Fig. 6 shows
 351 the block diagram of TRV implementation that is based
 352 on a finite-state machine (FSM) implementation. VHDL
 353 descriptions of the developed designs have been implemented
 354 using Spartan 6 xc6vlx40t-1fgg1156 [33] and Cyclone II
 355 EP2C20F484C7 [34] devices from Xilinx and Intel (formerly,
 356 Altera), respectively. The architectures have been designed for
 357 two different exposure times, 128 and 256 s. These exposure
 358 times are within the range of interest and have been selected
 359 since to divide by a power of 2 using binary representation is
 360 equivalent to displacements to the right of the data record,
 361 thus reducing the required area resources. In order to get
 362 these exposure times, the designs were developed taking into
 363 account the frequencies of the clock sources coming into the
 364 FPGA devices. 200 and 50 MHz clock sources were used for
 365 Spartan 6 and Cyclone II devices, respectively.

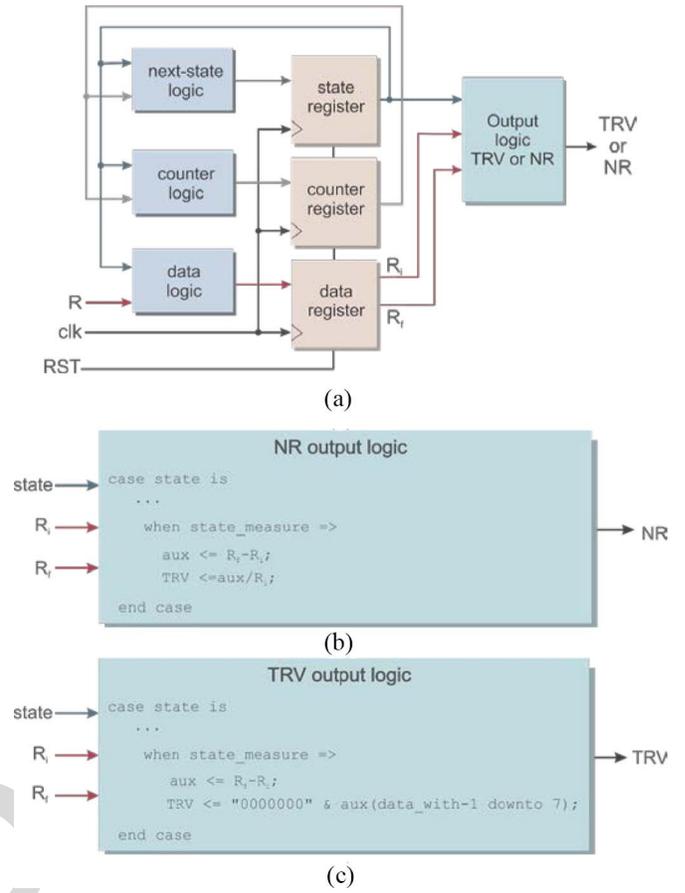


Fig. 6. (a) Block diagram of TRV or NR algorithm implemented in FPGA. (b) VHDL sentences for NR output logic for NR algorithm. (c) VHDL sentences for TRV output logic (for an exposure time of 128 s).

TABLE I
 AREA AND DELAY FIGURES FOR FPGA IMPLEMENTATION
 USING AN EXPOSURE TIME OF 128 S

Design	Spartan 6			
	Area (Slices)	Ratio	F _{max} (MHz)	Ratio
NR	99	1	29.49	1
TRV	25	0.25	478.87	0.06
Design	Cyclone II			
	Area (LEs)	Ratio	F _{max} (MHz)	Ratio
NR	374	1	20.27	1
TRV	83	0.22	189.04	0.11

Tables I and II summarize the area and maximum frequency
 figures for these FPGA implementations. It can be observed
 from these tables that TRV design occupies a much smaller
 area than NR design. Concretely, TRV design occupies
 around 75% less area than NR for both exposure times and
 FPGA devices. In addition to this, the high surface and the
 more complex structures lower significantly the operating
 frequency of the circuits. These tables also show how the
 NR designs in the Spartan 6 and Cyclone II fall short of
 the reference frequencies of 200 and 50 MHz. For instance,
 in case of the Spartan 6, the maximum frequency stops at

TABLE II
AREA AND DELAY FIGURES FOR FPGA IMPLEMENTATION
USING AN EXPOSURE TIME OF 256 S

Spartan 6				
Design	Area (Slices)	Ratio	F _{max} (MHz)	Ratio
NR	101	1	30.25	1
TRV	27	0.27	327.44	0.09
Cyclone II				
Design	Area (LEs)	Ratio	F _{max} (MHz)	Ratio
NR	377	1	20.07	1
TRV	86	0.23	199.20	0.11

29.29 and 30.25 MHz for an exposure time of 128 and 256 s, respectively. A similar situation occurs for Cyclone II devices and NR designs. To effectively use these circuits, a clock divider component should be implemented, increasing thus the area resources. In this sense, TRV designs substantially improve the maximum frequency, increasing around a 90% the maximum frequencies. For example, the maximum frequencies supported by TRV designs for Spartan 6 device are 478.87 and 327.44 MHz for an exposure time of 128 and 256 s, respectively, which satisfy the required frequency of 200 MHz. As a result, TRV designs in addition to reduce area occupation, allow reaching the required frequencies, without being necessary to include a clock divider component, which further increase the complexity.

IV. CONCLUSION

This paper proposes and develops a novel measurement algorithm for gas sensors based on single-walled CNTs. This algorithm not only optimizes the sensor performance in terms of time response and sensitivity but also facilitates the integration of the sensor in a final system, minimizing hardware resources, and power consumption.

The described algorithm is based on the measurement of the variation in resistance over time, what we define as time resistance variation (TRV). We demonstrate that only 74 s are necessary to get the maximum performance of the sensor response for ammonia detection and this value is applicable for different recovery strategies (passive desorption, external heating, and dc voltage). In the case of the conventional approach, measuring the NR does not get the best performance below 300 s for any of the recovery strategies analyzed. Although both calculations of TRV and NR involve a division, the practical computation of TRV can be reduced by a subtraction of two resistance values whereas the division in NR cannot be simplified, because the initial resistance changes over time. Therefore, from a computational point of view and in terms of circuit resources, TRV results in a faster solution, requiring a minimal number of electronic blocks for the hardware implementation to extract the sensor information. Thus, the hardware implementation in FPGA of NR and TRV designs has demonstrated that TRV design reduces the area resources and increases substantially the operating frequency.

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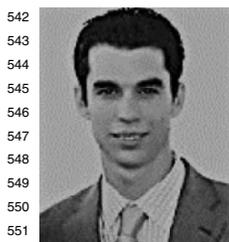
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